

2.0x1.25mm SMD CHIP LED LAMP

Part Number: APHBM2012SURKCGKC

Hyper Red Green

Features

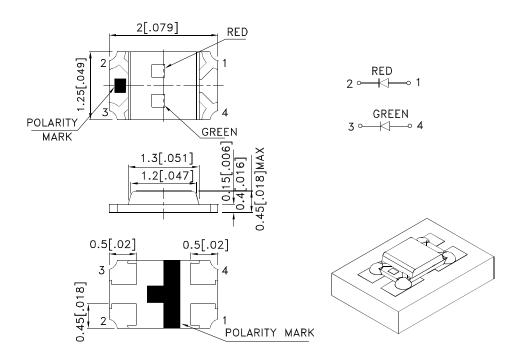
- 2.0mmx1.25mm SMT LED, 0.45mm max. thickness.
- Bi -color, low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





PAGE: 1 OF 6

ERP: 1203005979

SPEC NO: DSAG7623 **REV NO: V.5 DATE: MAR/26/2009** APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
APHBM2012SURKCGKC	Hyper Red (AlGaInP)	WATER CLEAR	70	220	120°
	Green (AlGaInP)	WATER CLEAR	36	80	

- Notes:
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	650 574		nm	Ir=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	Ir=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	IF=20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	٧	Ir=20mA
lR	Reverse Current	Hyper Red Green		10 10	uA	V _R = 5V

- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

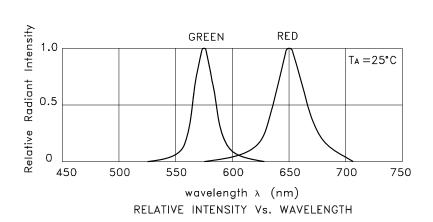
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units			
Power dissipation	75	75	mW			
DC Forward Current	30	30	mA			
Peak Forward Current [1]	185	150	mA			
Reverse Voltage		V				
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

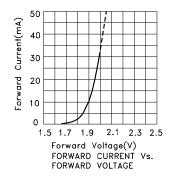
Note:

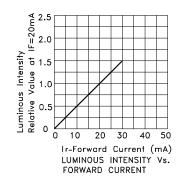
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

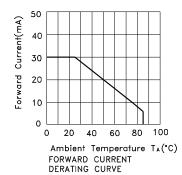
SPEC NO: DSAG7623 **REV NO: V.5** DATE: MAR/26/2009 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1203005979

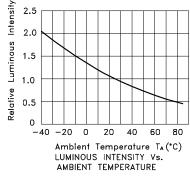


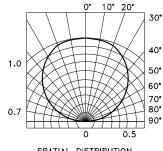
APHBM2012SURKCGKC Hyper Red









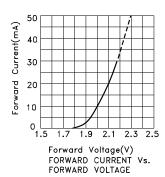


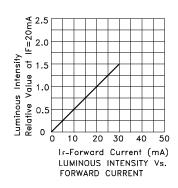
SPATIAL DISTRIBUTION

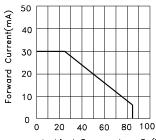
 SPEC NO: DSAG7623
 REV NO: V.5
 DATE: MAR/26/2009
 PAGE: 3 OF 6

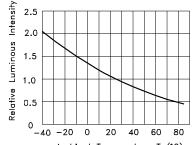
 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: D.M.Su
 ERP: 1203005979

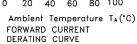
Green

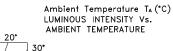


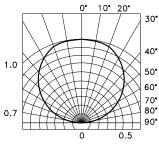












SPATIAL DISTRIBUTION

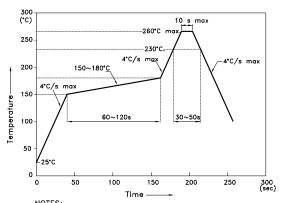
 SPEC NO: DSAG7623
 REV NO: V.5
 DATE: MAR/26/2009
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: D.M.Su
 ERP: 1203005979

APHBM2012SURKCGKC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



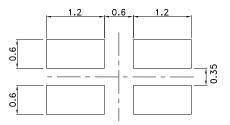
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

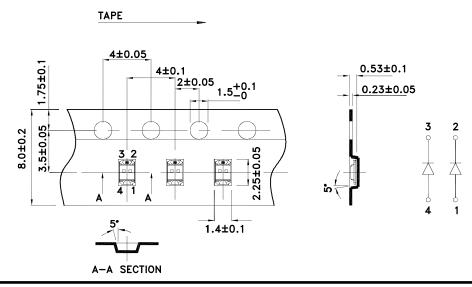
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



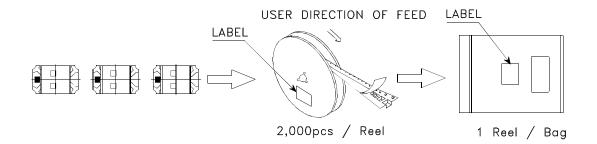
Tape Dimensions (Units: mm)

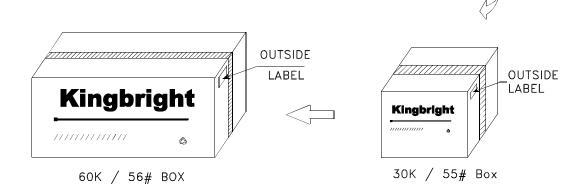


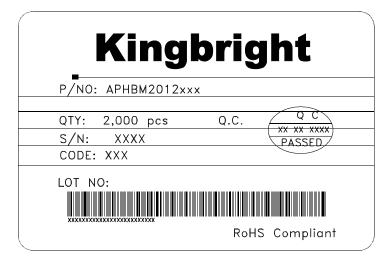
SPEC NO: DSAG7623 **REV NO: V.5 DATE: MAR/26/2009** PAGE: 5 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1203005979

PACKING & LABEL SPECIFICATIONS

APHBM2012SURKCGKC







SPEC NO: DSAG7623 APPROVED: WYNEC

REV NO: V.5 CHECKED: Allen Liu DATE: MAR/26/2009 DRAWN: D.M.Su

PAGE: 6 OF 6 ERP: 1203005979